# Smart LiB Gauge Battery Fuel Gauge LSI For 1-Cell Lithium-ion/ Polymer (Li+)

## Overview

LC709203F is a Fuel Gauge for a single lithium ion/polymer battery. It is part of our *Smart LiB Gauge* family of Fuel Gauges which measure the battery RSOC (Relative State Of Charge) using its unique algorithm called **HG-CVR**. The **HG-CVR** algorithm eliminates the use of a sense resistor and provides accurate RSOC information even under unstable conditions (e.g. changes of battery; temperature, loading, aging and self-discharge). An accurate RSOC contributes to the operating time of portable devices.

LC709203F is available in two small packages realizing the industries smallest PCB footprint for the complete solution. It has minimal parameters to be set by the user enabling simple, quick setup and operation.

#### Features

- **HG–CVR** Algorithm Technology
  - No External Sense Resistor
  - ◆ 2.8% Accuracy of RSOC
  - Accurate RSOC of Aging Battery
  - Automatic Convergence of Error
  - Adjustment for the Parasitic Impedance around the Battery
  - Simple and Quick Setup
- Low Power Consumption
- 3 μA Operational Mode
- Precision Voltage Measurement
  - ◆ ±7.5 mV
- Precision Timer
  - ◆ ±3.5%
- Alerts for Low RSOC and/or Low Voltage
- Temperature Compensation
  - Sense Thermistor Input
  - ♦ Via I<sup>2</sup>C
- Detect Battery Insertion
- I<sup>2</sup>C Interface (up to 400 kHz Supported)
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

## Applications

- Wireless Handsets
- Smartphones/PDA Devices
- MP3 Players
- Digital Cameras
- Portable Game Players
- USB-related Devices



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this data sheet.

XXX

= Year

= Month Code

= Lot Number

**ORDERING INFORMATION** 

See detailed ordering and shipping information on page 19 of

## **Application Circuit Example**



Figure 1. Example of an Application Schematic using LC709203F (Temperature Input via I<sup>2</sup>C)





LC709203F







WLCSP9 1.60x1.76 "Pb-Free, Halogen Free Type" (Bottom View)

Figure 4. Pin Assignment

## Table 1. PIN FUNCTION

WDFN8	WLP9	Pin Name	I/O	Description			
1	1B	TEST	I	Connect this pin to V <sub>SS</sub> .			
2	1A	V <sub>SS</sub>	_	Connect this pin to the battery's negative (-) pin.			
3	ЗA	V <sub>DD</sub>	_	Connect this pin to the battery's positive (+) pin.			
4	2A	ALARMB	0	This pin indicates alarm by low output(open drain). Pull-up must be done externally. Alarm conditions are specified by registers (0x13 or 0x14). Connect this pin to $V_{\rm SS}$ when not in use.			
5	3B	T <sub>SW</sub>	0	Power supply output for thermistor. This pin goes HIGH during temperature read operation. Resistance value of TSW (for thermistor pull-up) must be the same value as the thermistor. (Note 1)			
6	3C	T <sub>SENSE</sub>	I	Thermistor sense input. If you connect this pin to thermistor, insert 100 $\Omega$ resistance between them for ESD. (Note 1)			
7	1C	SDA	I/O	I <sup>2</sup> C Data pin (open drain). Pull-up must be done externally.			
8	2C	SCL	I/O	I <sup>2</sup> C Clock pin (open drain). Pull-up must be done externally.			
-	2B	NC	-	Don't care.			

1.  $T_{SW}$  and  $T_{SENSE}$  must be disconnected as Figure 1 when not in use.

## Table 2. ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = $25^{\circ}$ C, V<sub>SS</sub> = 0 V)

					S	pecificatio	n	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> (V)	Min	Тур	Max	Unit
Maximum Supply Voltage	V <sub>DD</sub> max	V <sub>DD</sub>		-	-0.3	-	+6.5	V
Input Voltage	V <sub>I</sub> (1)	T <sub>SENSE</sub>		-	-0.3	-	V <sub>DD</sub> + 0.3	
Output Voltage	V <sub>o</sub> (1)	T <sub>SW</sub>		-	-0.3	-	V <sub>DD</sub> + 0.3	
	V <sub>o</sub> (2)	ALARMB		-	-0.3	-		
Input/Output Voltage	V <sub>IO</sub> (1)	SDA, SCL		-	-0.3	-	+5.5	
Allowable Power Dissipation	P <sub>d max</sub>	WDFN8	$T_A = -40$ to	-	-	-	480	mW
		WLP9	+85°C	-	-	-	210	
Operating Ambient Temperature	T <sub>opr</sub>			-	-40	_	+85	°C
Storage Ambient Temperature	T <sub>stg</sub>			-	-55	-	+125	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# Table 3. ALLOWABLE OPERATING CONDITIONS (T<sub>A</sub> = -40 to +85°C, V<sub>SS</sub> = 0 V)

					S			
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> (V)	Min	Тур	Max	Unit
Operating Supply Voltage	V <sub>DD</sub> (1)	V <sub>DD</sub>		-	2.5	-	4.5	V
High Level Input Voltage	V <sub>IH</sub> (1)	T <sub>SENSE</sub>		2.5 to 4.5	0.7 V <sub>DD</sub>	-	V <sub>DD</sub>	
	V <sub>IH</sub> (2)	ALARMB, SDA, SCL		2.5 to 4.5	1.4	-	-	
Low Level Input Voltage	V <sub>IL</sub> (1)	T <sub>SENSE</sub>		2.5 to 4.5	V <sub>SS</sub>	-	0.25 V <sub>DD</sub>	
	V <sub>IL</sub> (2)	ALARMB, SDA, SCL		2.5 to 4.5	-	-	0.5	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

					S	pecificatio	า	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> (V)	Min	Тур	Мах	Unit
High Level Input Current	I <sub>IH</sub> (1)	SDA, SCL	V <sub>IN</sub> = V <sub>DD</sub> (including output transistor off leakage current)	2.5 to 4.5	_	_	1	μΑ
Low Level Input Current	I <sub>IL</sub> (1)	SDA, SCL	V <sub>IN</sub> = V <sub>SS</sub> (including output transistor off leakage current)	2.5 to 4.5	-1	-	-	
High Level Output Voltage	V <sub>OH</sub> (1)	T <sub>SW</sub>	I <sub>OH</sub> = -0.4 mA	3.0 to 4.5	$V_{DD} - 0.4$	-	-	V
	V <sub>OH</sub> (2)		I <sub>OH</sub> = -0.2 mA	2.5 to 4.5	$V_{DD} - 0.4$	-	-	
Low Level Output Voltage	V <sub>OL</sub> (1)	T <sub>SW</sub> , ALARMB,	I <sub>OL</sub> = 3.0 mA	3.0 to 4.5	-	-	0.4	
	V <sub>OL</sub> (2)	SDA, SCL	l <sub>OL</sub> = 1.3 mA	2.5 to 4.5	-	-	0.4	
Hysteresis Voltage	VHYS(1)	SDA, SCL		2.5 to 4.5	-	0.1 V <sub>DD</sub>	_	
Pin Capacitance	СР	All pins	Pins other than the pin under test $V_{IN} = V_{SS}$ $T_A = 25^{\circ}C$	2.5 to 4.5	-	10	-	pF
Reset Release Voltage (Note 2)	V <sub>RR</sub>	V <sub>DD</sub>			_	-	2.4	V
Initialization Time after Reset Release (Note 2)	T <sub>INIT</sub>			2.4 to 4.5	_	-	90	ms
Auto Sleep Set Time	T <sub>ATS</sub>			2.4 to 4.5	-	1	1.2	S
Time Measurement Accuracy	Τ <sub>ΜΕ</sub>		$T_A = -20^{\circ}C \text{ to } +70^{\circ}C$	2.5 to 4.5	-3.5	-	+3.5	%
Consumption Current	I <sub>DD</sub> (1)	V <sub>DD</sub>	Operational mode	2.5 to 4.5	-	3	4.5	μΑ
(Note 3)	I <sub>DD</sub> (2)		Sleep mode	2.5 to 4.5	-	1	2	
Voltage Measurement	V <sub>ME</sub> (1)	V <sub>DD</sub>	$T_A = +25^{\circ}C$	3.6	-7.5	-	+7.5	mV/cell
Accuracy	V <sub>ME</sub> (2)		$T_A = -20^{\circ}C \text{ to } +70^{\circ}C$	2.5 to 4.5	-20	-	+20	

## Table 4. ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = -40 to +85°C, V<sub>SS</sub> = 0 V)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Once V<sub>DD</sub> voltage exceeds over the V<sub>RR</sub>, this LSI will release RESET status. And the LSI goes into Sleep mode T<sub>INIT</sub> after it.
3. Consumption current is a value in the range of -20°C to +70°C.

Table 5. I <sup>2</sup> C SLAVE CHARACTERISTICS (T <sub>A</sub> = -40 to +85°C, V <sub>SS</sub> = 0 V)
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					Specific	ation	
Parameter	Symbol	Pin/Remarks	Conditions	V <sub>DD</sub> (V)	Min	Max	Unit
Clock Frequency	T <sub>SCL</sub>	SCL			-	400	kHz
Bus Free Time between STOP condition and START condition	T <sub>BUF</sub>	SCL, SDA	(See Figure 5)		1.3	-	μs
Hold Time (repeated) START condition. First clock pulse is generated after this interval	T <sub>HD:STA</sub>	SCL, SDA	(See Figure 5)		0.6	-	μs
Repeated START Condition Setup Time	T <sub>SU:STA</sub>	SCL, SDA	(See Figure 5)		0.6	-	μs
STOP Condition Setup Time	T <sub>SU:STO</sub>	SCL, SDA	(See Figure 5)		0.6	-	μs
Data Hold Time	T <sub>HD:DAT</sub>	SCL, SDA	(See Figure 5)		0	0.9	μs
Data Setup Time	T <sub>SU:DAT</sub>	SCL, SDA	(See Figure 5)		100	-	ns
Clock Low Period	T <sub>LOW</sub>	SCL	(See Figure 5)	2.5 to 4.5	1.3	-	μs
Clock High Period	T <sub>HIGH</sub>	SCL	(See Figure 5)		0.6	-	μs
Clock/Data Fall Time	Τ <sub>F</sub>	SCL, SDA			20 + 0.1C <sub>B</sub>	300	ns
Clock/Data Rise Time	T <sub>R</sub>	SCL, SDA			20 + 0.1C <sub>B</sub>	300	ns
Time-out Interval (Notes 4, 5)	T <sub>TMO</sub>	SCL, SDA	(See Figure 6)		9	11	s
Wake Up Time from Sleep Mode	T <sub>WU</sub>	SDA	(See Figure 7)		-	400	μs
SDA Low Pulse Width to Wake Up	T <sub>SP</sub>	SDA	(See Figure 7)	1	0.6	-	μs
Wake Up Retention Time from the Falling Edge of SDA	T <sub>WR1</sub>	SDA	(See Figure 7)		500	-	ms
Wake Up Retention Time from STOP Condition	T <sub>WR2</sub>	SCL, SDA	(See Figure 7)		500	-	ms

This LSI resets I<sup>2</sup>C communication if the communication takes more than T<sub>TMO</sub>. It initializes an internal timer to measure the interval when 4. it detects ninth clock pulse. It can receive a new START condition after the reset.

5. This LSI may lose I<sup>2</sup>C communication at this reset operation. Then if a master can't receive a response it must restart transaction from START condition.



Figure 5. I<sup>2</sup>C Timing Diagram



Figure 6. I<sup>2</sup>C Time-out Interval

## I<sup>2</sup>C Communication Protocol

Communication protocol type: I<sup>2</sup>C

Frequency: Supported up to 400 kHz

IC address [Slave Address]: 0x16 (It becomes "0001011X" when you write a binary, because the slave address is 7 bits. [X] = Rd/Wr.) This LSI will stretch the clock.

#### **Bus Protocols**

S	:	Start Condition
Sr	:	Repeated Start Condition
Rd	:	Read (bit value of 1)
Wr	:	Write (bit value of 0)
А	:	ACK (bit value of 0)
Ν	:	NACK (bit value of 1)
Р	:	Stop Condition
CRC-8	:	Slave Address to Last Data (CRC–8–ATM : ex.3778 mV : 0x16, 0x09, 0x17, 0xC2, 0x0E $ ightarrow$ 0x86)
	:	Master-to-Slave
	:	Slave-to-Master
	:	Continuation of protocol

#### **Read Word Protocol**

S Sr	Slave Address	Wr	A	Command Code	A		
Sr							
Sr							_
0.	Slave Address	Rd	А	Data Byte Low	А	Data Byte High	
-							
A	CRC-8	Ν	Р				
* When you do $0x0E \rightarrow 0x8$	-	e is not	the reli	ability of data. CRC-8-A	ΓM ex: (	5 bytes) 0x16, 0x09, 0x17,	0xC2,

#### Write Word Protocol

S	Slave Addres	S	Wr	А	Comm	and Co	de	А			
Data Byte	Low	А	Data	Byte Hi	gh	А	CRC	-8	А	Р	

\* When you do not add CRC–8, the Written data (Data byte Low/High) become invalid. CRC–8–ATM ex: (4 bytes) 0x16, 0x09, 0x55, 0xAA  $\rightarrow$  0x3B

#### Wake Up from Sleep Mode



Figure 7. I<sup>2</sup>C Wake up Timing Diagram

To wake up from Sleep mode, and to start  $I^2C$  communication, Host side must set SDA low prior to the  $I^2C$  communication. The Fuel Gauge LSI enables  $I^2C$  communication after the TWU time period which is measured from the falling edge of SDA, as above timing chart. This "Wake up condition" is invalid for the following two cases:

- After TWR1 timing following the falling edge of SDA, the Fuel Gauge LSI "Wake up condition" goes into autonomous disable. Once I<sup>2</sup>C communication is started, the operation doesn't go into disable until the TWR2 timing has elapsed after STOP condition (below case).
- 2. After TWR2 timing following I<sup>2</sup>C Bus STOP condition, the Fuel gauge LSI "Wake up condition" goes into autonomous disable.

If the "Wake up condition" goes into disable, set SDA low to once again wake up from the Sleep mode prior to the  $I^2C$  communication. If Operational mode is set, it is possible to start  $I^2C$  communication without this "Wake up operation".

# Notice for I<sup>2</sup>C Communication Shared with Another Device

When the I<sup>2</sup>C Bus<sup>m</sup> (on which the Fuel Gauge LSI is connected) is shared with another device the Fuel Gauge LSI must be in its operation mode before the other Device starts I<sup>2</sup>C communication.

#### Table 6. FUNCTION OF REGISTERS

Command Code	Register Name	R/W	Range	Unit	Description	Initial Value
0x04	Before RSOC	W	0xAA55: Initialize RSOC		RSOC initialization with sampled n voltage when 0xAA55 is set.	-
0x06	Thermistor B	R/W	0x0000 to 0xFFFF	1K	Sets B-constant of the thermistor to be measured.	0x0D34
0x07	Initial RSOC	W	0xAA55: Initialize RSOC	Executes F	SOC initialization when 0xAA55 is set.	-
0x08	Cell Temperature	R	0x0000 to 0xFFFF	0.1K	Displays Cell Temperature	0x0BA6
		W	0x09E4 to 0x0D04 (I <sup>2</sup> C mode)	(0.0°C = 0x0AAC)	Sets Cell Temperature in I <sup>2</sup> C mode	(25°C)
0x09	Cell Voltage	R	0x0000 to 0xFFFF	1 mV	Displays Cell Voltage	-
0x0A	Current Direction	R/W	0x0000: Auto mode 0x0001: Charge mode 0xFFFF: Discharge mode	Selects /	Auto/Charge/Discharge mode	0x0000
0x0B	APA (Adjustment Pack Application)	R/W	0x0000 to 0x00FF	1 mΩ	Sets Parasitic impedance	-
0x0C	APT (Adjustment Pack Thermistor)	R/W	0x0000 to 0xFFFF		Sets a value to adjust temperature measurement delay timing	
0x0D	RSOC	R/W	0x0000 to 0x0064	1%	Displays RSOC value based on a 0-100 scale	-
0x0F	ITE (Indicator to Empty)	R	0x0000 to 0x03E8	0.1%	Displays RSOC value based on a 0–1000 scale	-
0x11	IC Version	R	0x0000 to 0xFFFF	Displ	ays an ID number of an IC	-
0x12	Change Of The Parameter	R/W	0x0000 or 0x0001	S	elects a battery profile	0x0000
0x13	Alarm Low RSOC	R/W	0x0000: Disable 0x0001to0x0064: Threshold	1%	Sets RSOC threshold to generate Alarm signal	0x0008
0x14	Alarm Low Cell Voltage	R/W	0x0000: Disable 0x0001to0xFFFF: Threshold	1 mV	Sets Voltage threshold to generate Alarm signal	0x0000
0x15	IC Power Mode	R/W	0x0001: Operational mode 0x0002: Sleep mode		Selects Power mode	(Note 6)
0x16	Status Bit	R/W	0x0000: I <sup>2</sup> C mode 0x0001: Thermistor mode	Selects 1	Femperature obtaining method	0x0000
0x1A	Number of The Parameter	R	0x0301 or 0x0504	Displays Battery profile code		-

NOTE: 0xXXXX = Hexadecimal notation

6. See "Power-on Reset/Battery Insertion Detection" and Figure 17.

## Before RSOC (0x04)

This LSI will get initial RSOC by Open Circuit Voltage (OCV) of a battery. It is desirable for battery current to be less than 0.025C to get expected OCV. (i.e. less than 75 mA for 3000 mAh design capacity battery.) This LSI initializes RSOC by measured battery voltage in initial sequence. (See Figure 8) But if reported RSOC after reset release is not expected value, "Before RSOC" command (0x04 = AA55) or "Initial RSOC" command (0x07 = AA55) can initialize RSOC again.

"Before RSOC" command can obtain historical voltage data in-between Release reset and "Before RSOC" command timing. And this command initializes RSOC with the maximum battery voltage which was obtained. (See Figure 9) Don't use this command if battery is charged in the term.

## Thermistor B (0x06)

Sets B-constant of the thermistor to be measured. Refer to the specification sheet of the thermistor for the set value to use.

## Initial RSOC (0x07)

The LSI can be forced to initialize RSOC by sending the Before RSOC Command ( $0 \times 04 = AA55$ ) or the Initial RSOC Command ( $0 \times 07 = AA55$ ).



Figure 8. RSOC Automatic Initialization



Figure 9. Before RSOC Command

The LSI initializes RSOC by the measured voltage at that time when the Initial RSOC command is written. (See Figure 10). The maximum time to initialize RSOC after the command is written is 1.5 ms.

## Cell Temperature (0x08)

This register contains the cell temperature from  $-20^{\circ}$ C (0×09E4) to +60°C (0×0D04) measured in 0.1°C units.

In the Thermistor mode  $(0\times16 = 01)$  the LSI measures the attached thermistor and loads the temperature into the Cell Temperature register. In the Thermistor mode, the thermistor shall be connected to the LSI as shown in Figure 2. The temperature is measured by having TSW pin to provide power into the thermistor and TSENSE pin to sense the output voltage from the thermistor. Temperature measurement timing is controlled by the LSI, and the power to the thermistor is not supplied for other reasons except to measure the temperature.

In the I<sup>2</sup>C mode (0×16 = 00) the temperature is provided by the host processor. During discharge/charge the register should be updates when the temperature changes more than  $1^{\circ}$ C

#### Cell Voltage (0x09)

This register contains the voltage on V<sub>DD</sub> 1 mV units.

#### **Current Direction (0x0A)**

This register is used to control the reporting of RSOC. In Auto mode the RSOC is reported as it increases or decreases. In Charge mode the RSOC is not permitted to decrease. In Discharge mode the RSOC is not permitted to increase.

With consideration of capacity influence by temperature, we recommend operating in Auto because RSOC is affected by the cell temperature. A warm cell has more capacity than a cold cell. Be sure not to charge in the Discharge mode and discharge in the Charge mode; it will create an error.

An example of RSOC reporting is shown in Figures 11 and 12.



Figure 10. Initial RSOC Command







Figure 12. Charge Mode (An example with decreasing in temperature. A cold cell has less capacity than a warm cell. Therefore RSOC decreases without discharging in Auto mode)

#### Adjustment Pack Application (0x0B)

This register contains the adjustment value for a battery type to improve the RSOC precision. Figure 13 and Table 7 show typical values of APA according to the design capacities per 1 cell and battery type. When some batteries are connected in parallel, the design capacity per 1 cell is applied to the table. The APA values of Type–04 and Type–05 are used for battery type that is specified in Table 8. Please contact ON Semiconductor if you don't satisfy the RSOC precision. The deeper adjustment of APA may improve the accuracy.



Figure 13. Typical APA

#### Adjustment Pack Thermistor (0x0C)

This is used to compensate for the delay of the thermistor measurement caused by a capacitor across the thermistor. The default value has been found to meet most of circuits where a capacitor like showing in Figure 14 is not put.

Please contact ON Semiconductor if you have an unusual circuit implementation.

#### Table 7. TYPICAL APA

Design		APA(0x0B)	
Capacity of Battery	Туре–01, Туре–03	Type-06	Type–07
100 mAh	0x08	0x0D	0x07
200 mAh	0x0B	0x15	0x0C
500 mAh	0x10	0x20	0x18
1000 mAh	0x19	-	0x28
2000 mAh	0x2D	-	0x40
3000 mAh	0x36	-	0x4D

Design Capacity of Battery	APA(0x0B)		
	Type–04	Type–05	
2600 mAh	0x1A	0x0D	



Figure 14. An Example of a Capacitor Across the Thermistor

#### RSOC (0x0D)

RSOC is reported in 1% units over the range 0% to 100%. When this register is written in operational mode the data may be updated to close it to actual RSOC of a battery. Set Sleep mode to keep the data. Writing to this register is not necessary in normal operation. ITE (0x0F) will be updated with the writing too.

#### Indicator to Empty (0x0F)

This is the same as RSOC with a resolution of 0.1% over the range 0.0% to 100.0%.

#### IC Version (0x11)

This is an ID number of an LSI.

#### Change of the Parameter (0x12)

The LSI contains a data file comprised of two battery profiles. This register is used to select the battery profile to be used. See Table 8. Register Number of the Parameter (0x1A) contains identity of the data file.

The Data file is loaded during final test depending on the part number ordered.

Most of the time, battery nominal/rated voltage or charging voltage values are used to determine which profile data shall be used. Please contact ON Semiconductor if you cannot identify which profile to select.

## Alarm Low RSOC (0x13)

The ALARMB pin will be set low when the RSOC value falls below this value, will be released from low when RSOC value rises than this value. Set to Zero to disable. Figure 15.



Figure 15. Alarm Low RSOC

#### Alarm Low Cell Voltage (0x14)

The ALARMB pin will be set low if VDD falls below this value, will be released from low if VDD rises than this value. Set to Zero to disable. Figure 16.

## IC Power Mode (0x15)

The LSI has two power modes. Sleep (0x15 = 02) or Operational mode (0x15 = 01). In the Sleep mode only I<sup>2</sup>C communication functions. In the Operational mode all functions operate with full calculation and tracking of RSOC during charge and discharge.

If the battery is significantly charged or discharged during sleep mode, the RSOC will not be accurate. Moved charge

is counted continuously to measure the RSOC in Operational mode. If battery is discharged or charged in the Sleep mode, the count breaks off.

When it is switched from Sleep mode to Operational mode, RSOC calculation is continued by using the data which was measured in the previous Operational mode.



Figure 16. Alarm Low Cell Voltage

## Status Bit (0x16)

This selects the Thermistor mode. Thermistor mode (0x16 = 01) the LSI measures the attached thermistor and loads the temperature into the Cell Temperature register.

 $I^2C$  mode (0x16 = 00) the temperature is provided by the host processor.

#### Number of the Parameter (0x1A)

The LSI contains a data file comprised of two battery profiles. This register contains identity of the data file. Please see register *Change of the Parameter (0x12)* to select the battery profile to be used. See Table 8.

The Data file is loaded during final test depending on the part number ordered. This file can be loaded in the field if required.

Please contact ON Semiconductor if you cannot identify which profile to select.

ІС Туре	Battery Type	Nominal/Rated Voltage	Charging Voltage	Design Capacity	Number of the Parameter (0x1A)	Change of the Parameter (0x12)
LC709203Fxx-01xx	03	3.8 V	4.35 V	≥ 500 mAh	0x0301	0x0000
	01	3.7 V	4.2 V	-		0x0001
LC709203Fxx-03xx	06	3.8 V	4.35 V	< 500 mAh	0x0601	0x0000
	01	3.7 V	4.2 V	-		0x0001
LC709203Fxx-04xx	05	ICR18650-26H (SAMSUNG) UR18650ZY (Panasonic)		0x0504	0x0000	
	04				0x0001	
LC709203Fxx-05xx	07	3.85 V	4.4 V	-	0x0706	0x0000
	06	3.8 V	4.35 V	< 500 mAh		0x0001

#### Table 8. BATTERY PROFILE VS. REGISTER

#### HG-CVR

#### Hybrid Gauging by Current-Voltage Tracking with Internal Resistance

**HG-CVR** is ON Semiconductor's unique method which is used to calculate accurate RSOC. **HG-CVR** first measures battery voltage and temperature. Precise reference voltage is essential for accurate voltage measurement. LC709203F has accurate internal reference voltage circuit with little temperature dependency.

It also uses the measured battery voltage and internal impedance and Open Circuit Voltage (OCV) of a battery for the current measurement. OCV is battery voltage without load current. The measured battery voltage is separated into OCV and varied voltage by load current. The varied voltage is the product of load current and internal impedance. Then the current is determined by the following formulas.

$$V(VARIED) = V(MEASURED) - OCV$$
 (eq. 1)

$$I = \frac{V(VARIED)}{R(INTERNAL)}$$
 (eq. 2)

Where V(VARIED) is varied voltage by load current, V(MEASURED) is measured voltage, R(INTERNAL) is internal impedance of a battery. Detailed information about the internal impedance and OCV is installed in the LSI. The internal impedance is affected by remaining capacity, load-current, temperature, and more. Then the LSI has the information as look up table. **HG–CVR** accumulates battery coulomb using the information of the current and a steady period by a high accuracy internal timer. The remaining capacity of a battery is calculated with the accumulated coulomb.

#### How to Identify Aging

By repeating discharge/charge, internal impedance of a battery will gradually increase, and the Full Charge Capacity (FCC) will decrease. In coulomb counting method RSOC is generally calculated using the FCC and the Remaining Capacity (RM).

$$RSOC = \frac{RM}{FCC} \times 100\%$$
 (eq. 3)

Then the decreased FCC must be preliminarily measured with learning cycle. But **HG–CVR** can measure the RSOC of deteriorated battery without learning cycle. The internal battery impedance that **HG–CVR** uses to calculate the current correlates highly with FCC. The correlation is based on battery chemistry. The RSOC that this LSI reports using the correlation is not affected by aging.

Figures 24–26 show RSOC measurement result of a battery with decreased FCC due to its aging. The shown RSOC is based on the decreased FCC even with a battery with 80% FCC after executing 300 times of discharge/ charge.

#### Automatic Convergence of the Error

A problem of coulomb counting method is the fact that the error is accumulated over time – This error must be corrected. The general gauges using coulomb counting method must find an opportunity to correct it.

This LSI with **HG–CVR** has the feature that the error of RSOC converges autonomously, and doesn't require calibration opportunities. The error constantly converges in the value estimated from the Open Circuit Voltage. Figure 27 shows the convergent characteristic example from the initialize error.

Also, coulomb counting method cannot detect accurate residual change because the amount of the current from self-discharge is too small but **HG-CVR** is capable to deal with such detection by using the voltage information.

#### Simple and Quick Setup

In general, it is necessary to obtain multiple parameters for a fuel gauge and it takes a lot of resource and additional development time of the users. One of the unique features of LC709203F is very small number of parameters to be prepared by the beginning of battery measurement – the minimum amount of parameter which users may make is one because Adjustment pack application register has to

have one. Such simple and quick start-up is realized by having multiple profile data in the LSI to support various types of batteries. Please contact your local sales office to learn more information on how to measure a battery that cannot use already-prepared profile data.

#### Low Power Consumption

Low power consumption of  $3 \mu A$  is realized in the Operation mode. This LSI monitors charge/discharge condition of a battery and changes the sampling rate according to its change of current. Power consumption reduction without deteriorating its RSOC accuracy was enabled by utilizing this method.

#### **Power-on Reset/Battery Insertion Detection**

When this LSI detects battery insertion, it starts Power-on reset automatically. Once the battery voltage exceeds over the  $V_{RR}$ , it will release RESET status and will complete LSI initialization within  $T_{INIT}$  to enter into Operational mode. All registers are initialized after Power-on reset. Then I<sup>2</sup>C communication can be started.

LC709203FXE-0xMH sets itself into Sleep mode automatically after  $T_{ATS}$  from the end of initialization. Therefore set to operational mode manually after it enters into Sleep mode. LC709203FQH–0xTWG doesn't set itself into Sleep mode automatically. Figure 17.

This LSI will also execute system reset automatically if a battery voltage exceeds under the  $V_{RR}$  during operation. Furthermore after Change of the Parameter (0x12) command input it will execute LSI initialization like battery insertion. Figure 18.

## Parasitic Resistance

The LSI measures RSOC by using internal impedance of a battery. Therefore, the parasitic resistance which exists in  $V_{DD}/V_{SS}$  Lines between measured Battery or Battery Pack to the LSI can become an error factor. But the resistance of Lines which is not connected other than the LSI is not included. Figure 19.

The lower resistance may improve the RSOC precision. Please see LC709203F Application note for information about layout method of  $V_{DD}/V_{SS}$  Lines to reduce it.

## **Measurement Starting Flow**

After Reset release, users can start battery measurement by writing appropriate value into the registers by following the flow shown in Figures 20–21. Please refer to Register function section for more information about each register.



Figure 17. Power On Timing Diagram









## STARTING FLOW







## **TYPICAL CHARACTERISTICS**







## **TYPICAL CHARACTERISTICS**





Figure 25. Battery Capacity Deterioration



Figure 26. Discharge Characteristics of Deterioration Battery

## **TYPICAL CHARACTERISTICS**



Figure 27. Convergent Characteristic from the Initialize Error This Graph is the Example for Starting Point 48% (Includes 52% Error Case) Instead of 100% (No Error)

Device	Package	Shipping <sup>†</sup>
LC709203FQH-01TWG	WDFN8 3x4, 0.65P (Pb-Free / Halogen Free)	2,000 / Tape & Reel
LC709203FQH-02TWG	WDFN8 3x4, 0.65P (Pb-Free / Halogen Free)	2,000 / Tape & Reel
LC709203FQH-03TWG	WDFN8 3x4, 0.65P (Pb-Free / Halogen Free)	2,000 / Tape & Reel
LC709203FQH-04TWG	WDFN8 3x4, 0.65P (Pb-Free / Halogen Free)	2,000 / Tape & Reel
LC709203FXE-01MH	WLCSP9, 1.60x1.76 (Pb-Free / Halogen Free)	5,000 / Tape & Reel
LC709203FXE-02MH	WLCSP9, 1.60x1.76 (Pb-Free / Halogen Free)	5,000 / Tape & Reel
LC709203FXE-03MH	WLCSP9, 1.60x1.76 (Pb-Free / Halogen Free)	5,000 / Tape & Reel
LC709203FXE-04MH	WLCSP9, 1.60x1.76 (Pb-Free / Halogen Free)	5,000 / Tape & Reel
LC709203FXE-05MH	WLCSP9, 1.60x1.76 (Pb-Free / Halogen Free)	5,000 / Tape & Reel

#### Table 9. ORDERING INFORMATION

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

NOTE: IC performance may vary depend on the types of battery to be in use. Contact your local sales office for assistance in choosing the correct model.

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TUTUILITUIT 8X 0.65 → ← → ← 0.35 PITCH DIMENSIONS: MILLIMETERS

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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